WS2

1.F5

The F5 ba
dri ps*ig

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可靠性实验

外形尺寸

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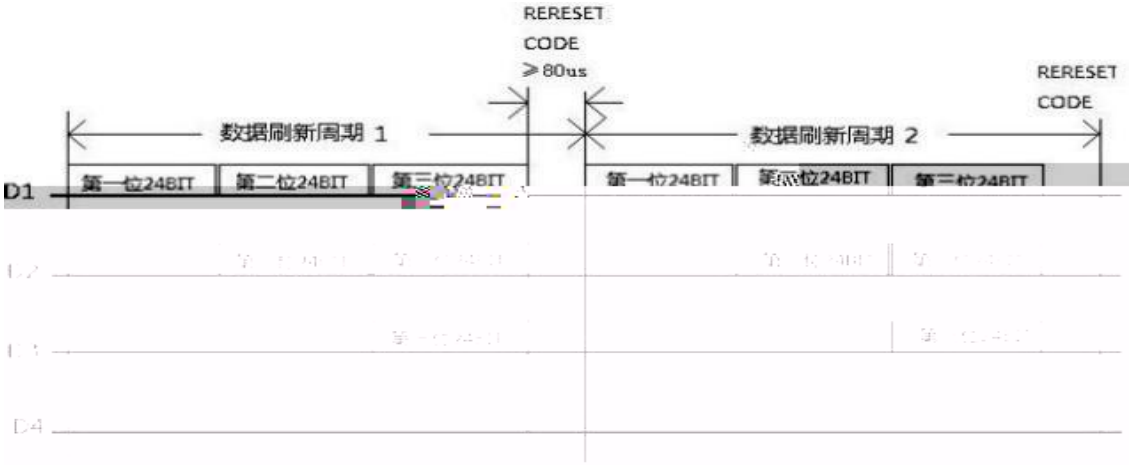
使用注意事项

Part 6

:Chip cascade method:

Date transmission mode



D1 MCU D2 D3 D4

Note: D1 refers to the data sent by MCU, and D2, D3 and D4 refer to the data automatically shaped and forwarded by cascade circuit

24bit 24bit data structure

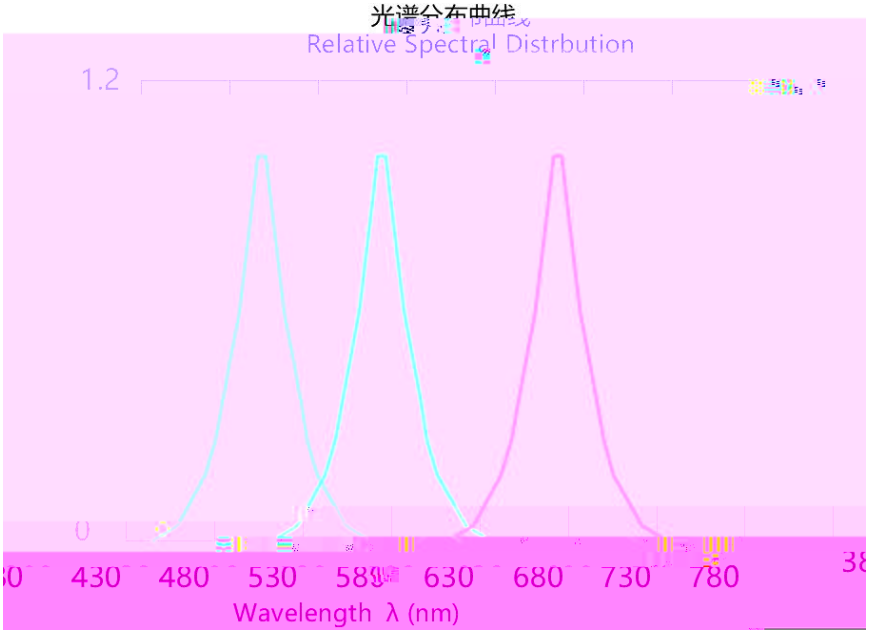
GRB

Note: high order first send, send data in the order of GrB

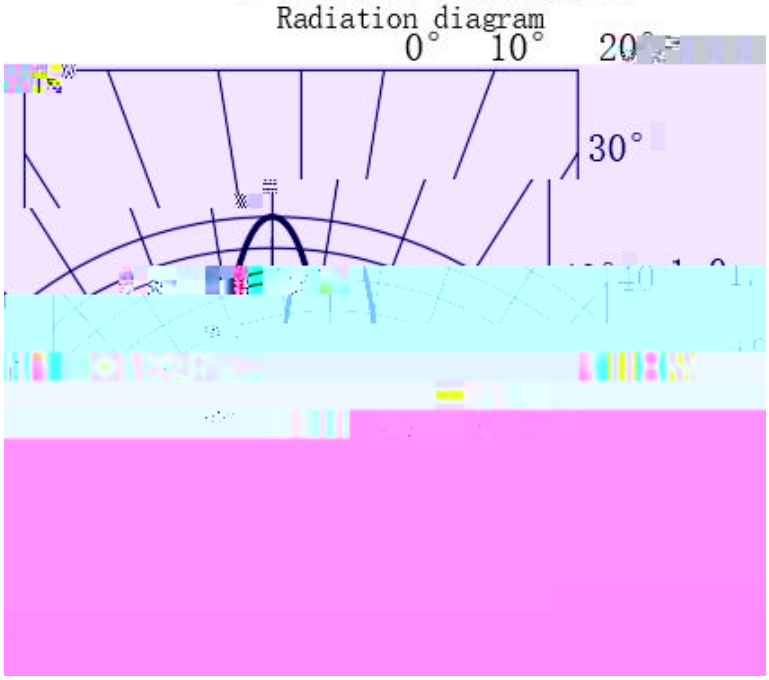
典型特性曲线

Typical Characteristics Curves

光谱分布曲线



相对辐射强度与空间角度关系



包装

Packaging

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In Bags

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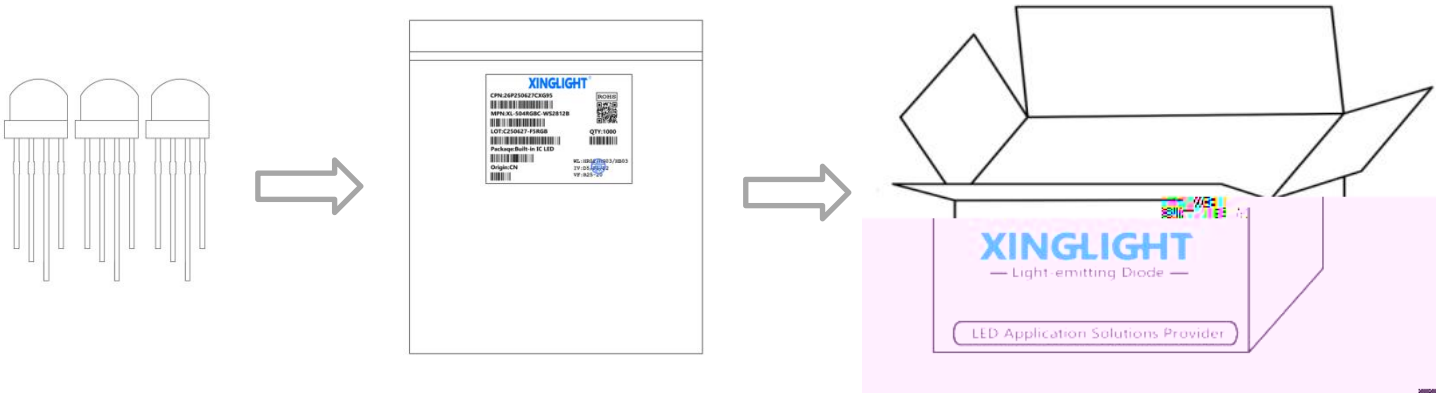
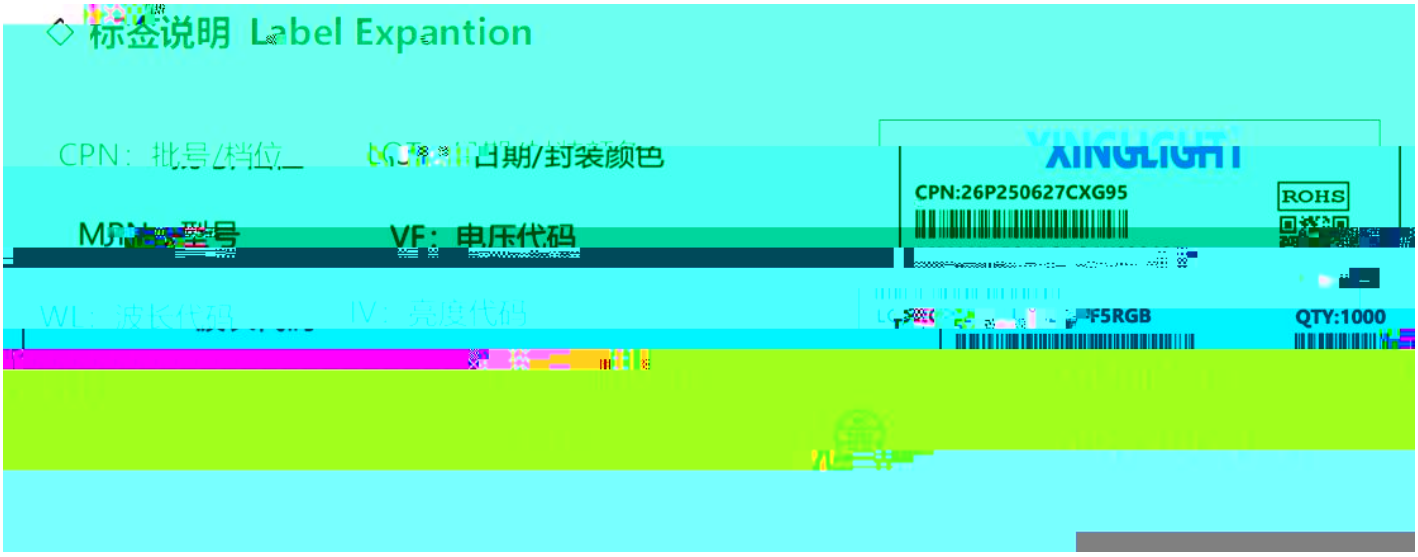
Moisture Proof and Anti-Electrostatic Foil Bag





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